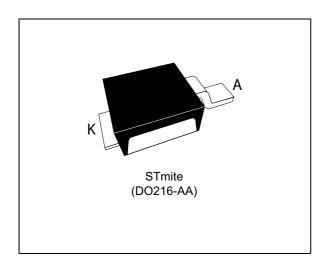
STPS120M



Power Schottky rectifier

Datasheet - production data



Features

- · Very small conduction losses
- · Negligible switching losses
- Extremely fast switching
- Low forward voltage drop for higher efficiency and extented battery life
- Low thermal resistance
- · Avalanche capability specified

Description

Single Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in STmite, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications. Due to the small size of the package this device fits battery powered equipment (cellular, notebook, PDA's, printers) as well chargers and PCMCIA cards.

Table 1. Device summary

| Symbol | Value | | |
|----------------------|--------|--|--|
| I _{F(AV)} | 1 A | | |
| V _{RRM} | 20 V | | |
| T _j (max) | 150 °C | | |
| V _F (typ) | 0.36 V | | |

This is information on a product in full production.

Characteristics STPS120M

1 Characteristics

Table 2. Absolute ratings (limiting values at T_{amb} = 25 °C, unless otherwise specified)

| Symbol | Parameter | | | Unit |
|---------------------------------|---|------------------------------------|-----|------|
| V_{RRM} | Repetitive peak reverse voltage | | | V |
| I _{F(RMS)} | Forward rms current | | | Α |
| I _{F(AV)} | Average forward current, δ = 0.5, square wave T_c = 140 °C | | 1 | Α |
| I _{FSM} | Surge non repetitive forward current | t _p = 8.3 ms sinusoidal | 50 | Α |
| P _{ARM} ⁽¹⁾ | Repetitive peak avalanche power $T_j = 125$ °C, $t_p = 10 \mu s$ | | 100 | W |
| T _{stg} | Storage temperature range | | | °C |
| T _j | Maximum operating junction temperature ⁽²⁾ | | | °C |

For pulse time duration deratings, please refer to Figure 3. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics Application notes AN1768, "Admissible avalanche power of Schottky diodes" and AN2025, "Converter improvement using Schottky rectifier avalanche specification".

Table 3. Thermal resistance

| Symbol | Parameter | Value | Unit |
|----------------------|---------------------|-------|------|
| R _{th(j-c)} | Junction to case | 20 | °C/W |
| $R_{th(j-a)}^{(1)}$ | Junction to ambient | | °C/W |

^{1.} Mounted with minimum recommended pad size, PC board FR4.

Table 4. Static electrical characteristics

| Symbol | Parameter | Test conditions | | Min. | Тур. | Max. | Unit |
|---|-------------------------|-------------------------|----------------------|------|------|------|------|
| | . (1) | T _j = 25 °C | M M | - | 1.3 | 3.9 | 4 |
| | | T _j = 100 °C | $V_R = V_{RRM}$ | - | 275 | 850 | |
| I _R ⁽¹⁾ | | T _j = 25 °C | V = 10 V | - | 0.6 | 2.0 | |
| I _R ⁽¹⁾ Reverse leakage current | T _j = 100 °C | V _R = 10 V | - | 145 | 450 | μΑ | |
| | | T _j = 25 °C | V _R = 5 V | - | 0.4 | 1.0 | |
| | | T _j = 100 °C | | - | 105 | 300 | |
| | | T _j = 25 °C | Ι – 1 Λ | - | 0.44 | 0.49 | |
| V _F ⁽¹⁾ Forward voltage drop | Forward voltage drep | T _j = 100 °C | I _F = 1 A | - | 0.36 | 0.41 | V |
| | Forward voilage drop | T _j = 25 °C | | - | 0.48 | 0.54 | V |
| | | T _j = 100 °C | I _F = 2 A | - | 0.42 | 0.48 | |

^{1.} Pulse test: $t_p = 380 \,\mu s$, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.34 \text{ x I}_{F(AV)} + 0.07 \text{ x I}_{F^2(RMS)}^2$$



^{2.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

STPS120M Characteristics

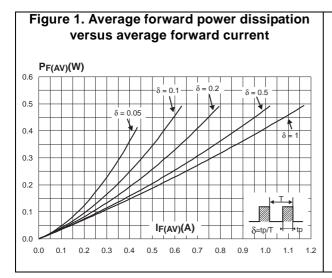
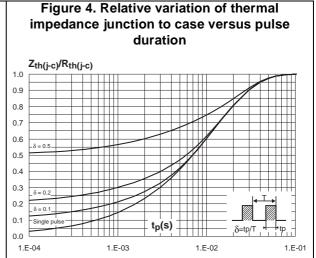
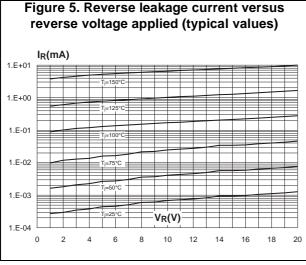
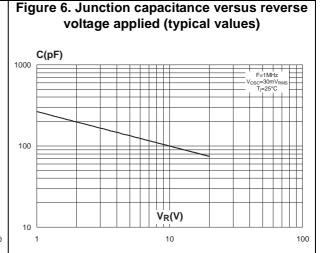


Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$) $I_{F(AV)}(A)$ 1.2 1.1 $R_{th(j-a)} = R_{th(j-c)}$ 1.0 0.9 0.8 0.7 0.6 0.5 0.3 0.2 0.1 δ= tp/T 0.0 25 100 125 150 0 50

Figure 3. Normalized avalanche power derating versus pulse duration (T_j = 125 °C)







Characteristics STPS120M

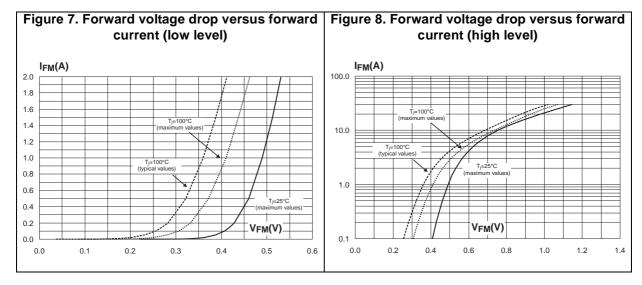
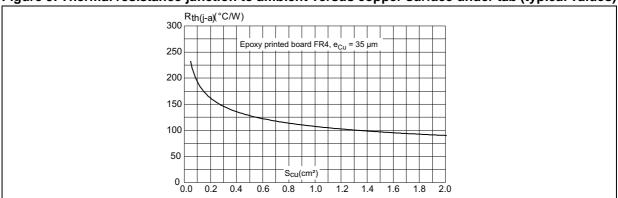


Figure 9. Thermal resistance junction to ambient versus copper surface under tab (typical values)



DocID8632 Rev 5

4/8

2 Package information

• Epoxy meets UL94, V0

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 STmite package information

L3

b2

H

L2

R1

R1

R1

L2

A1

D° to 6°

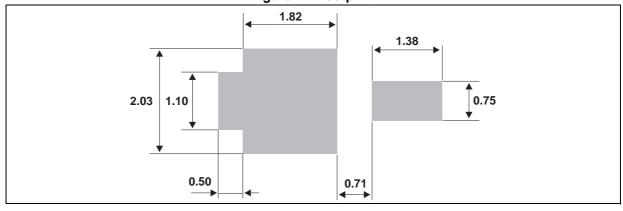
Figure 10. STmite package outline

Package information STPS120M

Table 5. STmite package mechanical data

| | | | Dimensions | | | |
|------|-------|-------------|------------|--------|--------|-------|
| Ref. | | Millimeters | | | Inches | |
| | Min. | Тур. | Max. | Min. | Тур. | Max. |
| А | 0.85 | 1.00 | 1.15 | 0.033 | 0.039 | 0.045 |
| A1 | -0.05 | | 0.05 | -0.002 | | 0.002 |
| b | 0.40 | | 0.65 | 0.016 | | 0.025 |
| b2 | 0.70 | | 1.00 | 0.027 | | 0.039 |
| С | 0.10 | | 0.25 | 0.004 | | 0.010 |
| D | 1.75 | 1.90 | 2.05 | 0.069 | 0.007 | 0.081 |
| Е | 1.75 | 1.90 | 2.05 | 0.069 | 0.007 | 0.081 |
| Н | 3.60 | 3.75 | 3.90 | 0.142 | 0.148 | 0.154 |
| L | 0.50 | 0.63 | 0.80 | 0.020 | 0.025 | 0.031 |
| L2 | 1.20 | 1.35 | 1.50 | 0.047 | 0.053 | 0.059 |
| L3 | | 0.50 | | | 0.019 | |
| R | 0.07 | | | 0.003 | | |
| R1 | 0.07 | | | 0.03 | | |

Figure 11. Footprint



3 Ordering information

Table 6. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|------------|---------|---------|---------|----------|---------------|
| STPS120M | 120 | STmite | 15.5 mg | 12000 | Tape and reel |

4 Revision history

Table 7. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| Jul-2003 | 2A | Last update. |
| 13-Sep-2004 | 3 | STmite package dimensions reference A1 change: from blank (min) to -0.05mm and from 0.10 (max) to 0.05mm. |
| 16-Feb-2011 | 4 | Migrated from EDOCS. |
| 20-Jul-2015 | 5 | Updated Table 4 and reformatted to current standard. |



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics - All rights reserved

57

8/8 DocID8632 Rev 5

单击下面可查看定价,库存,交付和生命周期等信息

>>STMicro(意法半导体)